NOTES, UNLESS OTHERWISE SPECIFIED:

- 1. The netname "V5P0V" represents connection to the +5.0V power buss.
- 2. The netname "V5P0VF" represents connection to the +5.0V filtered power buss.
- 3. The netname "V3P3V" represents connection to the +3.3V power buss
- 4. The netname "V1P0VREF" represents connection to the +1.0V reference buss
- 5. The netname "V1P0VREFBUF" represents connection to the +1.0V buffered reference buss.
- 6. The netname "GND" represents connection to the ground plane.
- 7. A "Z" suffix on a signal name indicates an active low signal.
- 8. All components with designators "U*", "Q*", and "D*" are electrostatic discharge sensitive.
- 9. All resistor values are in ohms.
- 10. All capacitor values in microfarads unless otherwise specified.



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	REVISIONS		
REV	DESCRIPTION	DATE	APPROVED
-	Draft Release	04/16/2014	HPC
Α	ECO 2141383: REV A Release	05/22/2014	HPC

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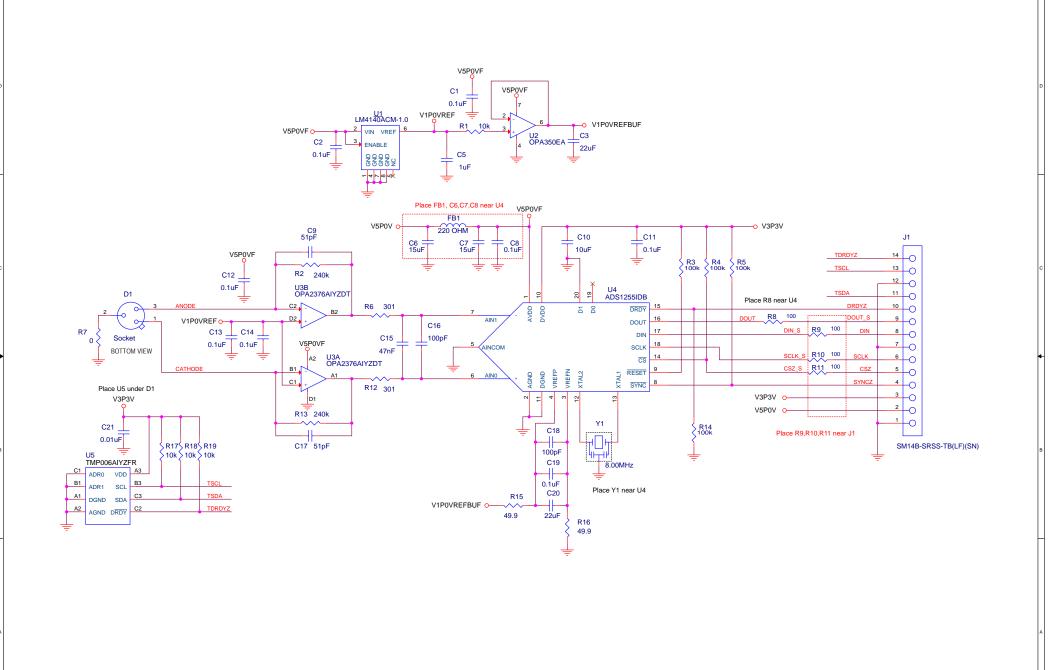
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			APVD MFG	TITLE				
-		0314CP	QA QA					gn
	NEXT ASSY	USED ON		A3	DRAWING NO	25140	20	REV C
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TIDA-00554

	TEXAS INSTRUMENTS	DWN ISSUE DATE	DATE 11/10/2015		DRAWING NO	2514020	REV
				SCALE		SHEET 2 OF 3	

Revision History

Rev. -- : Draft Release $\sim 04/16/2014$

Rev. A: ECO 2141383: ~ 05/22/2014

Rev. B: C9, C17 change value to 51pF, C15 change value to 47nF: $\sim 11/03/2014$ MR.

Rev. C: Changed reference voltage from 2.5V to 1V by replacing U1 with LM4140ACM 1.0 and removing C4.

This change maps the ADC dynamic range from +/-5V to +/-2V: ~ 11/11/2015 MR.

TIDA-00554

Schematic Revision History

	TEXAS INSTRUMENTS	DWN	DATE 05/22/2014		DRAWING NO 25	514020	REV
		1330E DATE		SCALE		SHEET 3 OF 3	

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